TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74HC670AP,TC74HC670AF

4 Word × 4 Bit Register File (3-state)

The TC74HC670A is a high speed 4-WORDS  $\times$  4-BITS REGISTER FILE fabricated with silicon gate C2MOS technology. It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The register file is organized as 4 words of 4 bits each. Separate read and write address inputs (RA, RB, and WA, WB)

and enable inputs  $(\overline{RE}, \overline{WE})$  are available permitting simultaneous writing into one word location and reading from another location.

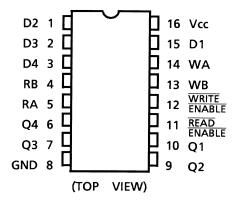
Four data inputs (D0~D3) are provided to store the 4-bit words. The write address inputs (WA, WB) determine the location of the stored word in the register. When write Enable ( $\overline{WE}$ ) is held low, the data is entered into addressed location. When  $\overline{WE}$  is held high, data and address inputs are inhibited. The data acquisition from the four registers is made possible by the read address inputs (RA, RB) when the Read Enable ( $\overline{RE}$ ) is held low. When RE is held high the data outputs are in the high impedance state.

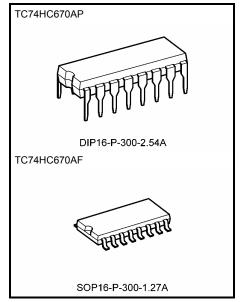
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

- High speed:  $t_{pd} = 23 \text{ ns (typ.)}$  at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 4 \mu A \text{ (max)}$  at  $T_a = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- · Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 4 mA (min)
- Balanced propagation delays: t<sub>p</sub>LH ≃ t<sub>p</sub>HL
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 74LS670

#### Pin Assignment



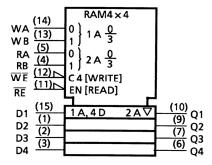


Weight

DIP16-P-300-2.54A : 1.00 g (typ.) SOP16-P-300-1.27A : 0.18 g (typ.)

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## **IEC Logic Symbol**



#### **Truth Table**

#### **Write Function Table**

| W  | rite Inpu | ıts | Words |            |    |       |  |  |  |
|----|-----------|-----|-------|------------|----|-------|--|--|--|
| WB | WA        | WE  | 0     | 1          | 2  | 3     |  |  |  |
| L  | L         | L   | Q = D | Q0         | Q0 | Q0    |  |  |  |
| L  | Н         | L   | Q0    | Q = D      | Q0 | Q0    |  |  |  |
| Н  | L         | L   | Q0    | Q0 $Q = Q$ |    | Q0    |  |  |  |
| Н  | Н         | L   | Q0    | Q0         | Q0 | Q = D |  |  |  |
| Х  | Х         | Η   | Q0    | Q0         | Q0 | Q0    |  |  |  |

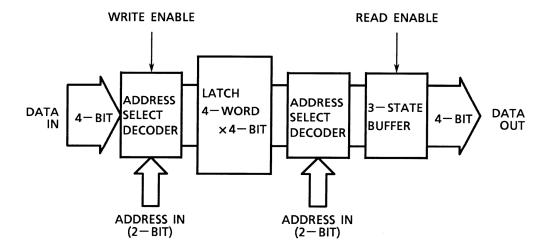
#### **Read Function Table**

| Re | ead Inpu | ıts | Outputs |      |      |      |  |  |
|----|----------|-----|---------|------|------|------|--|--|
| RB | RA       | RE  | Q1      | Q2   | Q3   | Q4   |  |  |
| L  | L        | L   | W0B1    | W0B2 | W0B3 | W0B4 |  |  |
| L  | Н        | L   | W1B1    | W1B2 | W1B3 | W1B4 |  |  |
| Н  | L        | L   | W2B1    | W2B2 | W2B3 | W2B4 |  |  |
| Н  | Н        | L   | W3B1    | W3B2 | W3B3 | W3B4 |  |  |
| Х  | Х        | Н   | Z       | Z    | Z    | Z    |  |  |

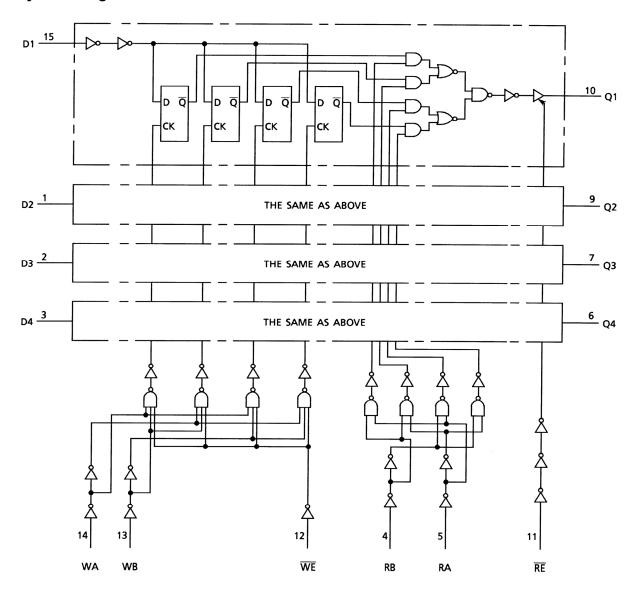
- X: Don't care
- Z: High impedance
- (Q = D): The four selected internal flip-flop outputs will assume the states applied to the four external data inputs.
- Q0: The level of Q before the indicated input conditions were established.

W0B1: The first bit of word 0, etc.

# **Block Diagram**



# **System Diagram**



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#### **Absolute Maximum Ratings (Note 1)**

| Characteristics                    | Symbol           | Rating                        | Unit |
|------------------------------------|------------------|-------------------------------|------|
| Supply voltage range               | V <sub>CC</sub>  | -0.5 to 7.0                   | V    |
| DC input voltage                   | V <sub>IN</sub>  | -0.5 to V <sub>CC</sub> + 0.5 | V    |
| DC output voltage                  | V <sub>OUT</sub> | $-0.5$ to $V_{CC} + 0.5$      | V    |
| Input diode current                | I <sub>IK</sub>  | ±20                           | mA   |
| Output diode current               | lok              | ±20                           | mA   |
| DC output current                  | lout             | ±25                           | mA   |
| DC V <sub>CC</sub> /ground current | Icc              | ±50                           | mA   |
| Power dissipation                  | PD               | 500 (DIP) (Note 2)/180 (SOP)  | mW   |
| Storage temperature                | T <sub>stg</sub> | -65 to 150                    | °C   |

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied until 300 mW.

## **Operating Ranges (Note)**

| Characteristics          | Symbol                          | Rating                                | Unit |
|--------------------------|---------------------------------|---------------------------------------|------|
| Supply voltage           | V <sub>CC</sub>                 | 2 to 6                                | V    |
| Input voltage            | V <sub>IN</sub>                 | 0 to V <sub>CC</sub>                  | V    |
| Output voltage           | V <sub>OUT</sub>                | 0 to V <sub>CC</sub>                  | ٧    |
| Operating temperature    | T <sub>opr</sub>                | −40 to 85                             | °C   |
|                          |                                 | 0 to 1000 (V <sub>CC</sub> = 2.0 V)   |      |
| Input rise and fall time | t <sub>r</sub> , t <sub>f</sub> | 0 to 500 (V <sub>CC</sub> = 4.5 V)    | ns   |
|                          |                                 | 0 to 400 ( $V_{CC} = 6.0 \text{ V}$ ) |      |

Note: The operating ranges must be maintained to ensure the normal operation of the device.
Unused inputs must be tied to either VCC or GND.

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# **Electrical Characteristics**

## **DC Characteristics**

|                                  |                 | Test Condition  |                            | Ta = 25°C           |      |      | Ta = -40 to 85°C |      | Unit |      |  |
|----------------------------------|-----------------|---|----------------------------|---------------------|------|------|------------------|------|------|------|--|
| Characteristics                  | Symbol          |   |                            | V <sub>CC</sub> (V) | Min  | Тур. | Max              | Min  | Max  | Unit |  |
|                                  |                 |   |                            | 2.0                 | 1.50 | _    | _                | 1.50 | _    |      |  |
| High-level input voltage         | $V_{IH}$        |   | _                          | 4.5                 | 3.15 | _    | _                | 3.15 | _    | V    |  |
| G                                |                 |   |                            | 6.0                 | 4.20 | _    | _                | 4.20 | _    |      |  |
|                                  |                 |   |                            | 2.0                 | _    | _    | 0.50             |      | 0.50 |      |  |
| Low-level input voltage          | $V_{IL}$        |   | _                          | 4.5                 | _    | _    | 1.35             | _    | 1.35 | V    |  |
| Ğ                                |                 |   |                            | 6.0                 | _    | _    | 1.80             |      | 1.80 |      |  |
|                                  | V <sub>ОН</sub> |   |                            | 2.0                 | 1.9  | 2.0  | _                | 1.9  | _    |      |  |
|                                  |                 | V <sub>IN</sub><br>= V <sub>IH</sub> or<br>V <sub>IL</sub>  | $I_{OH} = -20 \mu A$       | 4.5                 | 4.4  | 4.5  | _                | 4.4  | _    |      |  |
| High-level output voltage        |                 |   |                            | 6.0                 | 5.9  | 6.0  | _                | 5.9  | _    | V    |  |
|                                  |                 |   | $I_{OH} = -4 \text{ mA}$   | 4.5                 | 4.18 | 4.31 | _                | 4.13 | _    |      |  |
|                                  |                 |   | $I_{OH} = -5.2 \text{ mA}$ | 6.0                 | 5.68 | 5.80 | _                | 5.63 | _    |      |  |
|                                  |                 | VIN   | I <sub>OL</sub> = 20 μA    | 2.0                 | _    | 0.0  | 0.1              | _    | 0.1  |      |  |
|                                  |                 |   |                            | 4.5                 | _    | 0.0  | 0.1              |      | 0.1  |      |  |
| Low-level output voltage         | V <sub>OL</sub> | $=V_{IH}$ or  |                            | 6.0                 | _    | 0.0  | 0.1              |      | 0.1  | V    |  |
|                                  |                 | V <sub>IL</sub>   | I <sub>OL</sub> = 4 mA     | 4.5                 | _    | 0.17 | 0.26             | _    | 0.33 |      |  |
|                                  |                 |   | $I_{OL} = 5.2 \text{ mA}$  | 6.0                 |      | 0.18 | 0.26             |      | 0.33 |      |  |
| 3-state output off-state current | I <sub>OZ</sub> | V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>V <sub>OUT</sub> = V <sub>CC</sub> or GND |                            | 6.0                 |      |      | ±0.5             | _    | ±5.0 | μА   |  |
| Input leakage current            | I <sub>IN</sub> | V <sub>IN</sub> = V <sub>CC</sub> or GND  |                            | 6.0                 |      | _    | ±0.1             | _    | ±1.0 | μА   |  |
| Quiescent supply current         | Icc             | $V_{IN} = V_C$  | <sub>C</sub> or GND        | 6.0                 |      |      | 4.0              | _    | 40.0 | μА   |  |

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## Timing Requirements (input: $t_r = t_f = 6$ ns)

| Characteristics     | Symbol             | Test Condition | Test Condition      |      |       | Ta =<br>-40 to<br>85°C | Unit |
|---------------------|--------------------|----------------|---------------------|------|-------|------------------------|------|
|                     |                    |                | V <sub>CC</sub> (V) | Тур. | Limit | Limit                  |      |
| Minimum pulse width |                    |                | 2.0                 | _    | 75    | 95                     |      |
| (WE)                | t <sub>W (L)</sub> | _              | 4.5                 | _    | 15    | 19                     | ns   |
| ( WE )              |                    |                | 6.0                 |      | 13    | 16                     |      |
| Minimum set-up time |                    |                | 2.0                 |      | 50    | 65                     |      |
| (Dn- WE)            | ts                 | _              | 4.5                 | _    | 10    | 13                     | ns   |
| (Dn- WE)            |                    |                | 6.0                 |      | 9     | 11                     |      |
| Minimum set-up time |                    |                | 2.0                 |      | 0     | 0                      |      |
| (WA, WB- WE)        | ts                 | _              | 4.5                 | _    | 0     | 0                      | ns   |
| (VVA, VVD- VVL )    |                    |                | 6.0                 | _    | 0     | 0                      |      |
| Minimum hold time   |                    |                | 2.0                 | _    | 5     | 5                      |      |
| (Dn- WE)            | t <sub>h</sub>     | _              | 4.5                 | _    | 5     | 5                      | ns   |
| (BIF WE)            |                    |                | 6.0                 | _    | 5     | 5                      |      |
| Minimum hold time   |                    |                | 2.0                 | _    | 0     | 0                      |      |
| (WA, WB- WE)        | t <sub>h</sub>     | _              | 4.5                 | _    | 0     | 0                      | ns   |
| (VVA, VVD- VVE)     |                    |                | 6.0                 | -    | 0     | 0                      |      |
| Minimum latch time  |                    |                | 2.0                 | _    | 75    | 95                     |      |
| (WE -RA, RB)        | t <sub>latch</sub> | (Note)         | 4.5                 | _    | 15    | 19                     | ns   |
| ( WE -IVA, IVD)     |                    |                | 6.0                 | _    | 13    | 16                     |      |

Note: t<sub>latch</sub> is the time allowed for the internal output of the latch to assume the state of new data.

This is important only when attempting to read from a location immediately after that location has received new data.

## AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $Ta = 25^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

| Characteristics             | Symbol           | Test Condition      |   | Тур. | Max | Unit |
|-----------------------------|------------------|---------------------|---|------|-----|------|
| Output transition time      | t <sub>TLH</sub> |                     |   | 4    | 8   | ns   |
| Cutput transition time      | t <sub>THL</sub> |                     |   | _    |     | 113  |
| Propagation delay time      | t <sub>pLH</sub> |                     |   | 23   | 34  | ns   |
| (RA, AB-Qn)                 | t <sub>pHL</sub> | _                   | _ |      |     | 113  |
| Propagation delay time      | t <sub>pLH</sub> |                     |   | 24   | 38  | ne   |
| ( WE -Qn)                   | t <sub>pHL</sub> | _                   | _ | 24   | 3   | ns   |
| Propagation delay time      | t <sub>pLH</sub> |                     |   | 22   | 32  | ns   |
| (Dn-Qn)                     | t <sub>pHL</sub> | _                   |   | 22   | 32  | 115  |
| 3-state output enable time  | t <sub>pZL</sub> | $R_{l} = 1 k\Omega$ |   | 11   | 18  | ns   |
| 3-State output enable time  | t <sub>pZH</sub> | 1/2 - 1 /22         |   | 11   | 10  | 10   |
| 3-state output disable time | t <sub>pLZ</sub> | $R_{l} = 1 k\Omega$ |   | 11   | 15  | ne   |
|                             | t <sub>pHZ</sub> | 11/2 - 1 1/22       |   | ''   | 15  | ns   |



## AC Characteristics ( $C_L = 50 \text{ pF}$ , input: $t_r = t_f = 6 \text{ ns}$ )

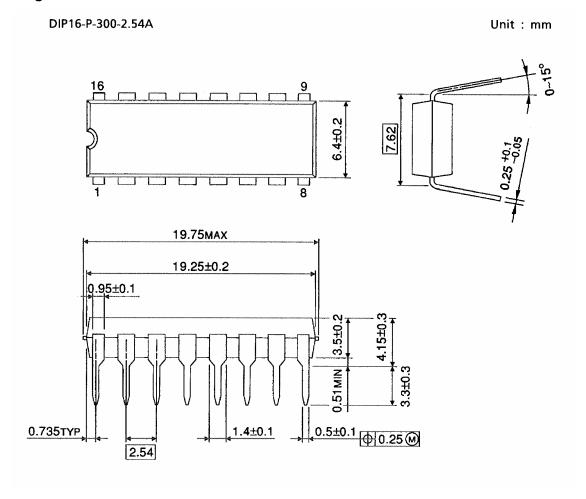
|                        | 0 1 1                                | Test Condition            |                         | -   | Ta = 25°C | )   | Ta = -40 to 85°C |     |      |
|------------------------|--------------------------------------|---------------------------|-------------------------|-----|-----------|-----|------------------|-----|------|
| Characteristics        | Symbol                               |                           | V <sub>C</sub> C<br>(V) | Min | Тур.      | Max | Min              | Max | Unit |
|                        | <b>t-</b>                            |                           | 2.0                     | _   | 30        | 75  | _                | 95  |      |
| Output transition time | t <sub>TLH</sub><br>t <sub>THL</sub> | _                         | 4.5                     | _   | 8         | 15  | _                | 19  | ns   |
|                        | ЧHL                                  |                           | 6.0                     |     | 7         | 13  | —                | 16  |      |
| Propagation delay      | <b>+</b>                             |                           | 2.0                     | _   | 90        | 195 |                  | 245 |      |
| time                   | t <sub>pLH</sub>                     | _                         | 4.5                     | _   | 27        | 39  | _                | 49  | ns   |
| (RA, AB-Qn)            | t <sub>pHL</sub>                     |                           | 6.0                     |     | 22        | 33  | —                | 42  |      |
| Propagation delay      | t <sub>pLH</sub>                     |                           | 2.0                     | _   | 95        | 220 |                  | 275 |      |
| time                   |                                      | _                         | 4.5                     | _   | 28        | 44  | _                | 55  | ns   |
| (WE -Qn)               | t <sub>pHL</sub>                     |                           | 6.0                     |     | 22        | 37  | —                | 47  |      |
| Propagation delay      | t <sub>pLH</sub>                     |                           | 2.0                     | _   | 90        | 185 |                  | 230 |      |
| time                   | •                                    | _                         | 4.5                     | _   | 26        | 37  | _                | 46  | ns   |
| (Dn-Qn)                | t <sub>pHL</sub>                     |                           | 6.0                     |     | 20        | 31  | —                | 39  |      |
|                        | t <sub>p</sub> ZH                    |                           | 2.0                     | _   | 46        | 110 | _                | 140 |      |
| Output enable time     | •                                    | $R_L = 1 \text{ k}\Omega$ | 4.5                     | _   | 14        | 22  | _                | 28  | ns   |
|                        | t <sub>pZL</sub>                     |                           | 6.0                     |     | 12        | 19  | —                | 24  |      |
|                        | t                                    |                           | 2.0                     | _   | 25        | 95  |                  | 120 |      |
| Output disable time    | t <sub>pLZ</sub>                     | $R_L = 1 \text{ k}\Omega$ | 4.5                     | _   | 14        | 19  | _                | 24  | ns   |
| t <sub>pHZ</sub>       |                                      | 6.0                       |                         | 12  | 16        |     | 20               |     |      |
| Input capacitance      | C <sub>IN</sub>                      | _                         |                         | -   | 5         | 10  | _                | 10  | pF   |
| Output capacitance     | C <sub>OUT</sub>                     | _                         |                         |     | 10        | _   | _                | _   | pF   |
| Power dissipation      | C <sub>PD</sub>                      |                           |                         |     | 101       |     |                  |     | n.E  |
| capacitance            | (Note)                               |                           |                         |     | 101       |     |                  |     | pF   |

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$ICC (opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$$

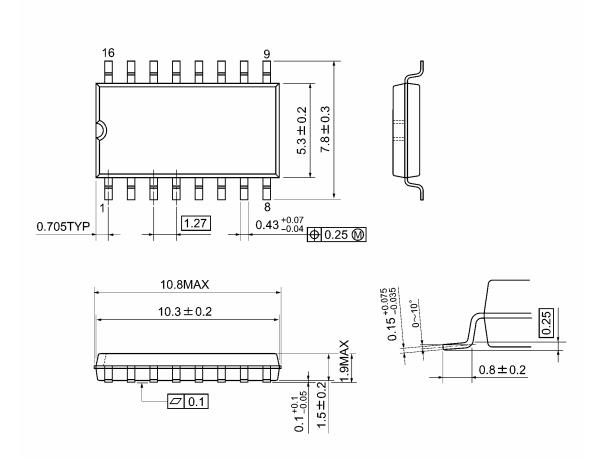
# **Package Dimensions**



Weight: 1.00 g (typ.)

# **Package Dimensions**

SOP16-P-300-1.27A Unit: mm



Weight: 0.18 g (typ.)

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20070701-EN GENERAL

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